

editorial calendar 2022

In addition to specific subjects, each issue of CS China will carry news, features and research from the full spectrum of the compound semiconductor industry. Contents are provided by Compound Semiconductor's expert journalists and complimented by contributed articles and features from respected companies in the community. A regular dedicated section is also provided by IHS IMS Research, the leading independent supplier of market research and consultancy to the global electronics industry.

CS China is published in Simplified Chinese and all contents are edited and translated by experienced editors and experts in the field.

	FEB / MAR Issue date: Feb 28 Booking: Feb 8 Materials: Feb 21 Editorial: Jan 28	APR / MAY Issue date: Apr 22 Booking: Apr 8 Materials: Apr 15 Editorial: Mar 25	JUN / JUL Issue date: Jun 24 Booking: Jun 10 Materials: Jun 17 Editorial: May 27
Cover Story	GaN microwave devices	SiC module package	InP Optoelectronics
Tech Features	SiC power electronics	Micro-LED	VCSEL laser
Column	SiC substrate	GaN power electronics technology	SiC process
Special Supplements	Compound Semiconductor Market	5G applications	Electric vehicle applications
Bonus Distribution	Semicon China Shanghai, Mar 23-25 Laser World of Photonics China, Shanghai, Mar 17-19	SNEC International PV Power Expo, May	Guangdong Int'l Lighting Fair, Jun

	AUG / SEP Issue date: Aug 26 Booking: Aug 12 Materials: Aug 19 Editorial: Jul 29	OCT / NOV Issue date: Oct 28 Booking: Oct 14 Materials: Oct 21 Editorial: Sep 23	DEC / JAN Issue date: Dec 23 Booking: Dec 9 Materials: Dec 16 Editorial: Dec 2
Cover Story	Gallium oxide device	Integrated package	Visible light communication
Tech Features	Deep UV LED	AlN material	Photonic integrated
Column	SiC epitaxy	GaAs device	SiC bipolar device
Special Supplements	Wide Band Gap Semiconductor Industry	Data center applications	Rail transit application
Bonus Distribution	Semicon Taiwan, Sept CIOE, Sep, Shenzhen EDICON China, Sep, Beijing	China Solid-State Lighting, Nov	

eFocus schedule

Date	Theme
Jan 12	GaN microwave devices
Feb 09	SiC power electronic devices
Mar 09	SiC module package
Apr 13	5G applications
May 11	Gallium oxide device
Jun 08	Deep UV LED
Jul 13	InP Optoelectronics
Aug 10	VCSEL laser
Sep 14	AlN material
Oct 12	GaAs device
Nov 09	Photonic integration
Dec 14	SiC bipolar device